

# 10 GHz to 40 GHz, 2-Way RF Splitter Combiner

#### **FEATURES**

- ▶ 2-way RF splitter combiner
- ▶ Frequency range: 10 GHz to 40 GHz
- ▶ Insertion loss (excess of 3 dB):
  - ▶ -1 dB from 10 GHz to 18 GHz
  - ▶ -1.1 dB from 18 GHz to 27 GHz
- ▶ Return loss (Port S1):
  - ▶ -15 dB from 10 GHz to 18 GHz
  - ▶ -12 dB from 18 GHz to 27 GHz
- ▶ Isolation:
  - ▶ -20 dB at 10 GHz to 18 GHz
  - ▶ -23 dB from 18 GHz to 27 GHz
- ▶ 1.460 mm × 1.460 mm × 0.500 mm, wafer level chip-scale package (WLCSP)

#### **APPLICATIONS**

- General-purpose microwave signal distribution
- ▶ Phased-array satellite communication (SATCOM) systems
- Phased-array radar systems

### **GENERAL DESCRIPTION**

The ADAR5001 is a 1-to-2 Wilkinson power splitter that is designed for space-constrained microwave signal distribution applications. Excess insertion loss ranges from −1.0 dB (from 10 GHz to 18 GHz) and −1.1 dB (from 18 GHz to 27 GHz). The two outputs are matched in both phase and amplitude, making the ADAR5001 ideal for signal distribution applications requiring low time skew between channels. The ADAR5001 can also be used as a combiner, combining input signals at the P1 and P2 ports to an output at the S1 port. The ADAR5001 is housed in a compact, 1.460 mm × 1.460 mm × 0.500 mm WLCSP, which makes it ideal for use in planar, phased-array antenna systems that require a tight pitch between elements.

The ADAR5001 is fabricated on a passive silicon process, and it is specified to operate from  $-40^{\circ}$ C to  $+85^{\circ}$ C.

#### **FUNCTIONAL BLOCK DIAGRAM**

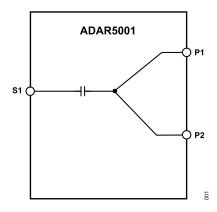


Figure 1. Functional Block Diagram

**Data Sheet** 

# **ADAR5001**

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# **REVISION HISTORY**

3/2024—Revision 0: Initial Version

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# **SPECIFICATIONS**

Source and load impedance = 50  $\Omega,$  and  $T_{\text{A}}$  = 25°C, unless otherwise noted.

Table 1. Specifications

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
OPERATING CONDITIONS					
Frequency Range		10		40	GHz
NSERTION LOSS (Excess of 3.0 dB)	S1 to P1, P2				
	10 GHz to 18 GHz		-1.0		dB
	18 GHz to 27 GHz		-1.1		dB
	27 GHz to 38 GHz		-1.4		dB
	38 GHz to 40 GHz		-2.0		dB
INSERT LOSS FLATNESS	S1 to P1, P2				
	10 GHz to 18 GHz		0.4		dB
	18 GHz to 27 GHz		0.5		dB
	27 GHz to 38 GHz		0.3		dB
	38 GHz to 40 GHz		1.0		dB
INSERTION LOSS MISMATCH	P1 to P2				
	10 GHz to 18 GHz		0.04		dB
	18 GHz to 27 GHz		0.03		dB
	27 GHz to 38 GHz		0.08		dB
	38 GHz to 40 GHz		0.25		dB
NSERTION PHASE MISMATCH	P1 to P2				
	10 GHz to 18 GHz		0.2		dB
	18 GHz to 27 GHz		0.2		dB
	27 GHz to 38 GHz		0.5		dB
	38 GHz to 40 GHz		2.5		dB
RETURN LOSS	All other ports terminated				
S1	· · · · · · · · · · · · · · · · · · ·				
	10 GHz to 18 GHz		-15		dB
	18 GHz to 27 GHz		-12		dB
	27 GHz to 38 GHz		-14		dB
	38 GHz to 40 GHz		-20		dB
P1, P2	00 01.2.10 10 01.2				
,	10 GHz to 18 GHz		-11		dB
	18 GHz to 27 GHz		-15		dB
	27 GHz to 38 GHz		-20		dB
	38 GHz to 40 GHz		-8		dB
SOLATION	P1 to P2, P2 to P1				
	10 GHz to 18 GHz		-20		dB
	18 GHz to 27 GHz		-23		dB
	27 GHz to 38 GHz		-15		dB
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### **ABSOLUTE MAXIMUM RATINGS**

Table 2. Absolute Maximum Ratings

Parameter	Rating
Maximum Input Power (Any Port)	34 dBm
Maximum Total Power (S1 Port)	37 dBm
Temperature	
Operating Range	-40°C to +85°C
Storage Range	-40°C to +150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## **ELECTROSTATIC DISCHARGE (ESD) RATINGS**

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

# **ESD Ratings for the ADAR5001**

Table 3. ADAR5001, 8-Ball WLCSP

ESD Model	Withstand Threshold (V)	Class	
HBM	2000	2	

#### **ESD CAUTION**



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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# PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

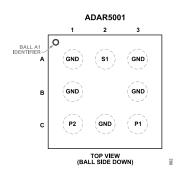


Figure 2. Pin Configuration (Top View)

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
A1, A3, B1, B3, C2	GND	Ground. Connect to a low impedance ground plane on the printed circuit board (PCB).
A2	S1	Sum and/or Split. The input port when the device is used as a splitter, and the output port when the device is used as a combiner. S1 is AC-coupled in the signal path but has a DC path to ground.
C1	P2	Port 2. The RF output when the device is used as a splitter, and the RF input when the device is used as a combiner. P2 has a DC path to ground.
C3	P1	Port 1. The RF output when the device is used as a splitter, and the RF input when the device is used as a combiner. P1 has a DC path to ground.

## **INTERFACE SCHEMATICS**

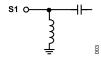


Figure 3. S1 Interface Schematic

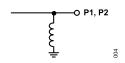


Figure 4. P1, P2 Interface Schematic

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### TYPICAL PERFORMANCE CHARACTERISTICS

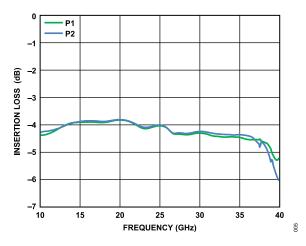


Figure 5. Insertion Loss vs. Frequency

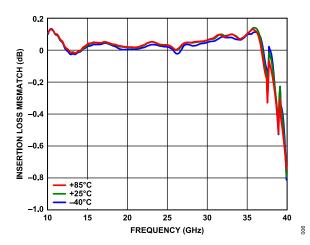


Figure 6. Insertion Loss Mismatch vs. Frequency and Temperature, Normalized to P1 at Same Temperature

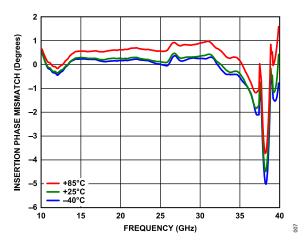


Figure 7. Insertion Phase Mismatch vs. Frequency and Temperature, Normalized to P1 at Same Temperature

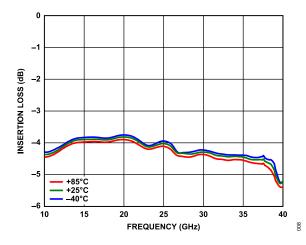


Figure 8. Insertion Loss P1 vs. Frequency and Temperature

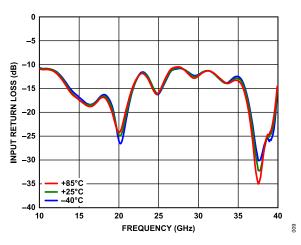


Figure 9. S1 Input Return Loss vs. Frequency and Temperature

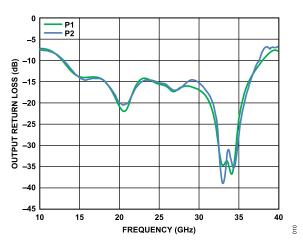


Figure 10. Output Return Loss vs. Frequency (P1, P2)

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# **TYPICAL PERFORMANCE CHARACTERISTICS**

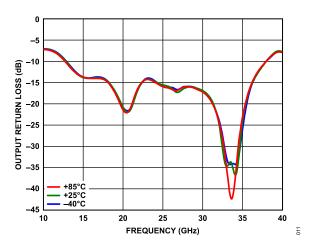


Figure 11. Output Return Loss P1 vs. Frequency and Temperature

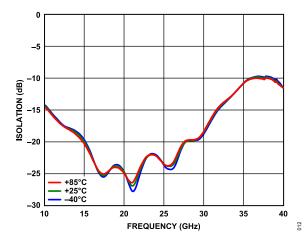


Figure 12. Isolation P2 to P1 vs. Frequency and Temperature

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## THEORY OF OPERATION

The ADAR5001 is a 1-to-2 Wilkinson power splitter and combiner. While the S1 port is AC-coupled in the signal path, it has a DC path to ground.

The P1 and P2 ports also have DC paths to ground. As a result, if the DC bias level on any of the ports is not equal to zero, the ports must be externally AC-coupled.

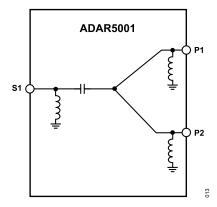


Figure 13. ADAR5001 Simplified Block Diagram

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## **OUTLINE DIMENSIONS**

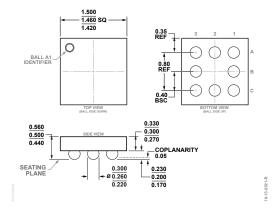


Figure 14. 8-Ball Wafer Level Chip Scale Package [WLCSP] (CB-8-8) Dimensions shown in millimeters

Updated: February 17, 2024

## **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Packing Quantity	Package Option
ADAR5001ACBZ	-40°C to +85°C	CHIPS W/SOLDER BUMPS/WLCSP	Reel, 1	CB-8-8
ADAR5001ACBZ-R7	-40°C to +85°C	CHIPS W/SOLDER BUMPS/WLCSP	Reel, 3000	CB-8-8

<sup>&</sup>lt;sup>1</sup> Z = RoHS Compliant Part.

## **EVALUATION BOARDS**

Table 5. Evaluation Boards

Model <sup>1</sup>	Description
ADAR5001-EVALZ	Evaluation Board

<sup>&</sup>lt;sup>1</sup> Z = RoHS Compliant Part.

